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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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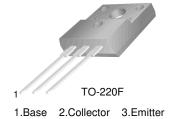




## KSB1098

## **Low Frequency Power Amplifier**

- Low Speed Switchng Industrial Use
- Complement to KSD1589



## **PNP Silicon Darlington Transistor**

## Absolute Maximum Ratings $T_{C}$ =25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	- 100	V
V <sub>CEO</sub>	Collector-Emitter Voltage	- 100	V
V <sub>EBO</sub>	Emitter-Base Voltage	- 7	V
I <sub>C</sub>	Collector Current (DC)	- 5	Α
I <sub>CP</sub>	*Collector Current (Pulse)	- 8	Α
I <sub>B</sub>	Base Current	- 0.5	Α
P <sub>C</sub>	Collector Dissipation (T <sub>a</sub> =25°C)	2	W
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)	20	W
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 55 ~ 150	°C

<sup>\*</sup> PW≤300μs, Duty Cycle≤10%

### **Electrical Characteristics** $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = -100V, I_{E} = 0$			- 1	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = -5V, I_{C} = 0$			- 3	mA
h <sub>FE1</sub>	* DC Current Gain	$V_{CE} = -2V, I_{C} = -3A$	2000		15K	
h <sub>FE2</sub>		$V_{CE} = -2V, I_{C} = -5A$	500			
V <sub>CE</sub> (sat)	* Collector-Emitter Saturation Voltage	$I_C = -3A, I_B = -3mA$			- 1.5	V
V <sub>BE</sub> (sat)	* Base-Emitter Saturation Voltage	$I_C = -3A, I_B = -3mA$			- 2	V
t <sub>ON</sub>	Turn ON Time	$V_{CC} = -50V, I_{C} = -3A$		0.5		μs
t <sub>STG</sub>	Storage Time	$I_{B1} = -I_{B2} = -3mA$		1		μs
t <sub>F</sub>	Fall Time	$R_L = 17\Omega$		1		μs

<sup>\*</sup> Pulse Test: PW≤350μs, Duty Cycle≤2% Pulsed

## **h**<sub>FE</sub> Classification

Classification	R	0	Υ
h <sub>FE1</sub>	2000 ~ 5000	3000 ~ 7000	5000 ~ 15000

# **Typical Characteristics**

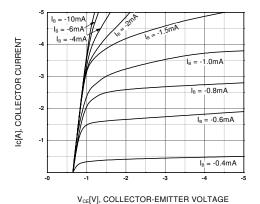


Figure 1. DC current Gain

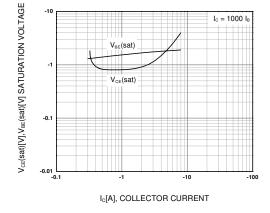


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

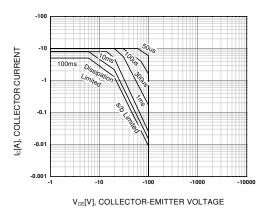


Figure 3. Safe Operating Area

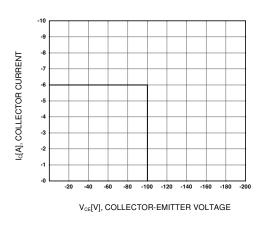


Figure 4. Reverse Bias Safe Operating Area

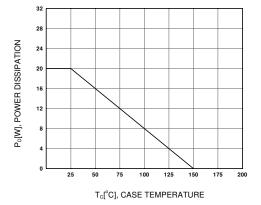
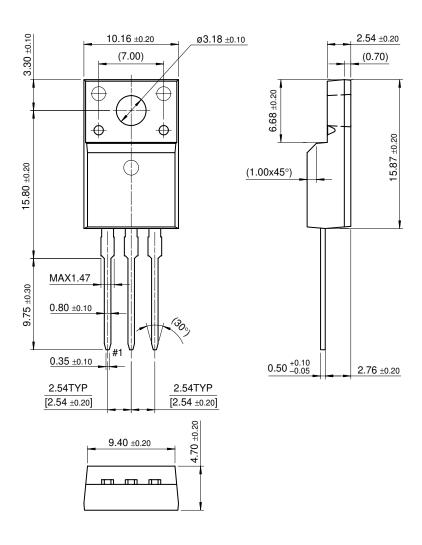


Figure 5. Power Derating

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# **Package Demensions**

# TO-220F



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Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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